PCN Number:	201605260	<u> </u>			F	PCN Date: 6/2		6/2/2016	
)S171I		•	. Sit Date.		5, 2, 2010	
Customer Contact:									
Change Type:									
Assembly Site			Design	ТГ	7	Wafer	Bumi	o Site	
Assembly Process		☐ Data Sheet			Ī	Wafer Bump Material			
Assembly Materials			Part number change			Wafer Bump Process			
Mechanical Specification			Test Site			Wafer Fab Site			
Packing/Shipping/Labeling			Test Process			Wafer Fab Materials			
Wafer Fab Process								Process	
Notification Details Description of Change:									
Texas Instruments Incorporated is announcing an information only notification.									
The product datasheet(s) is being updated as summarized below. The following change history provides further details.									
TEXAS INSTRUMENTS	TEXAS TMDS171, TMDS171I							TMDS171I	
				LSEN7C	-OC	TOBER 2015	-REVISE	ED APRIL 2016	
Changes from Revision B (February 2016) to Revision C Page									
Changed pin 36 Description From: TX_TERM_CTL = L: 150 - 300 Ω To: TX_TERM_CTL = L: Reserved in the <i>Pin Functions</i> table									
Added OE to V _{IL} "Low-level input voltage" in the <i>Recommended Operating Conditions</i> table									
Added OE to V _{IH} "High-level input voltage" in the <i>Recommended Operating Conditions</i> table									
Changed Figure 23 Delete the ASS and ASS are Miller to the Ass are t									
Deleted the VDD_ramp and VCC_ramp MIN values in Table 1 Changed TV_TERM_CTL_T_L to Received in Table 3									
Changed TX_TERM_CTL = L to Reserved in Table 3									
Added Note to 11–400-kbps in Table 8									
Added Note to 11–400-kbps in Table 10									
The datasheet number will be changing.									
Device Family		<u> </u>	Change From:			(Chan	ge To:	
TMDS171, TMDS171I			SLLSEN7B			SLLSEN7C			
These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/TMDS171									
Reason for Change:									
To more accurately reflect device characteristics.									
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.									
Changes to product identification resulting from this PCN:									
None.									
Product Affected:									
TMDS171IRGZR	TMDS171I	RGZ	T TMDS171RG2	ZR		TMDS171RGZT			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com